Draft Synopsis V1.0 Co-60 Total Ionizing Dose (TID) Testing of the Analog Devices OP-27 Operational Amplifier

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I. Introduction

This study was undertaken to determine the total ionizing dose susceptibility of the Analog Devices OP-27 Operational Amplifier. The device was biased and operating when exposed to a Cobalt-60 environment at the Goddard Space Flight Center (GSFC) Co-60 Radiation Effects Facility.

II. Devices Tested

Five parts were exposed for this testing. These devices were manufactured by Analog Devices and were characterized prior to exposure. The devices were from date code 0215. Complete device details are given in Table I.

III. Test Facility

Facility: GSFC Co-60 Radiation Effects Facility

Source: Cobalt 60

Dose Rate: approximately 0.1 - 2 krads(Si)/hour

IV. Test Methods

Five OP-27 devices (1, 2, 3, 4 and 5) were exposed to the Co-60 radiation environment while under bias. The bias circuit is shown in Figure 1, with $V^+ = 5$ volts, $V^- = -5$ volts and $V_{\rm in} = 3$ volts. The dose rate for the exposure ranged from 0.1 - 2 krads(Si)/hour.

The devices were characterized prior to entering the radiation chamber and at nine times during the exposure, the devices were removed to the Cobalt cell and characterized. The nine post exposure characterizations were done at approximately 1, 2, 4, 7, 9, 13, 17, 24 and 30 krads(Si). Finally, after the 30 krad(Si) exposure, the devices were placed in a 100 °C oven for approximately 1 week and were then characterized a final time. The complete listing of exposure dates and dose rates are given in Table II.

The parametric measurements done for this testing were performed using the Tektronix 2465A Parametric Analyzer, Analog Oscilloscope, 8116A Pulse/Function Generator, and a HP 6654A Power Supply. The parameters measured, the conditions for that measurement and the data sheet specifications are contained in Table III.

V. Results

The results from the testing are detailed in Table IV. After 30 krads(Si) exposure and a 1 week 100 °C anneal, all parameters were within specification. Therefore, the OP-27 can be considered to have a total dose failure greater than 30 krads(Si).

TABLE I. Part Information

Generic Part Number: OP27

GOES ITT Part Number OP27

Charge Number:

Analog Devices Manufacturer:

1D 0215FF Lot Date Code (LDC):

> Quantity Tested: 6

Serial Number of Control Samples: 0

Serial Numbers of Radiation Samples: 1,2,3,4 and 5

> Operational Amplifier Part Function:

Part Technology: Bipolar

Package Style: 8-Pin DIP

Test Equipment:

Parametric Analyzer, Tektronix 2465A Analog Oscilloscope, 8116A Pulse/Function Generator, HP 6654A Power Supply

Chris Palor Test Engineer:

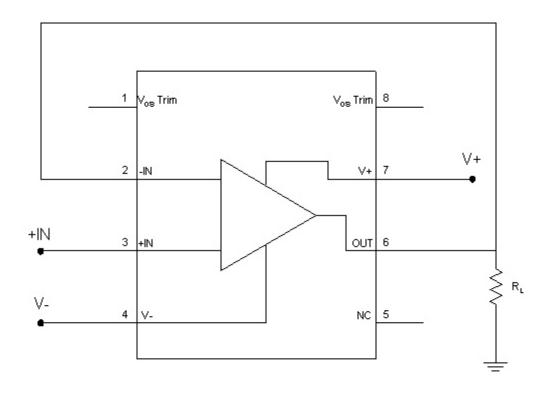


Figure 1. Radiation Bias Circuit for OP27

- Notes: 1. $R_L = 1K \square \pm 5\%$. 2. +IN = 3.0V, V + = +5V, V = -5V.

TABLE II. Radiation Schedule for OP27

EVENT	DATE
1) INITIAL ELECTRICAL MEASUREMENTS	07/09/03
2) 1.0 KRAD IRRADIATION (1.000 KRADS/HOUR)	07/09/03
POST-1.0 KRAD ELECTRICAL MEASUREMENT	07/09/03
3) 2.0 KRAD IRRADIATION (1.000 KRADS/HOUR)	07/09/03
POST-2.0 KRAD ELECTRICAL MEASUREMENT	07/09/03
4) 4.0 KRAD IRRADIATION (1.000 KRADS/HOUR)	07/10/03
POST-4.0 KRAD ELECTRICAL MEASUREMENT	07/10/03
5) 7.0 KRAD IRRADIATION (1.530 KRADS/HOUR)	07/10/03
POST-7.0 KRAD ELECTRICAL MEASUREMENT	07/10/03
6) 9.0 KRAD IRRADIATION (0.2352 KRADS/HOUR)	07/10/03
POST-9.0 KRAD ELECTRICAL MEASUREMENT	07/11/03
7) 13.0 KRAD IRRADIATION (2.000 KRADS/HOUR)	07/11/03
POST-13.0 KRAD ELECTRICAL MEASUREMENT	07/11/03
8) 17.0 KRAD IRRADIATION (1.730 KRADS/HOUR)	07/11/03
POST-17.0 KRAD ELECTRICAL MEASUREMENT	07/11/03
9) 24.0 KRAD IRRADIATION (0.1098 KRADS/HOUR)	07/11/03
POST-24.0 KRAD ELECTRICAL MEASUREMENT	07/14/03
10) 30.0 KRAD IRRADIATION (0.3072 KRADS/HOUR)	07/14/03
POST-30.0 KRAD ELECTRICAL MEASUREMENT	07/15/03
11) 168 HOUR ANNEALING @25°C	07/21/03
POST-168 HOUR ANNEAL ELECTRICAL MEASUREMENT	07/21/03

PARTS WERE IRRADIATED AND ANNEALED UNDER BIAS, SEE FIGURE 1.

Table III. Electrical Characteristics of OP-27

Test				Spec.	Lim.
#	Parameter	Units	Test Conditions	min	max
1	+Icc	mA	$+V_{S} = 15V, V_{O} = 0V$	0.0	4.67
2	-Icc	mA	$-V_{\rm S} = -15V, V_{\rm O} = 0V$	-4.67	0.0
3	Power_Diss	mW	$V_{CC} = \pm 15V$, $V_O = 0V$		140
4	VOS	□V	$+V_{S} = 15V$, $-V_{S} = -15V$, warmed up	-25	25
5	P_IIB	nA	$+V_{S} = 15V, -V_{S} = -15V$	-40	40
6	N_IIB	nA	$+V_{S} = 15V, -V_{S} = -15V$	-40	40
7	IIOS	nA	$+V_{S} = 15V, -V_{S} = -15V$	-35	35
8	CMRR	dB	$V_{CM} = \pm 11V$	114	
9	PSRR	dB	$+V_S = \pm 4V$ to $\pm 18V$	100	
10	P_VOUT_2k	V	$R_L = 2k$	12.0	
11	N_VOUT_2k	V	$R_L = 2k$		-12.0
12	P_VOUT_600	V	$R_L = 600$	10.0	
13	N_VOUT_600	V	$R_L = 600$		-10.0
14	P_AOL_2k	V/mV	$R_L = 2k \square$, $V_O = +10V$	1000	
15	N_AOL_2k	V/mV	$R_L = 2k \square$, $V_O = -10V$	1000	
16	P_AOL_600		$R_L = 600 \square$, $V_O = +10 V$	800	
17	N_AOL_600		$R_L = 600 \square$, $V_O = -10 V$	800	
18	Slew Rate	V/∏s	$C_L = 100 pF, R_L = 2k[], V_O = \pm 5V$	1.70	

TABLE IV: Summary of Electrical Measurements after Total Dose Exposures and Annealing for OP27 /1, 2

							Total Dose Exposure (kRads Si)								Total Dose Exposure (kRads Si)							Annealing				
					Initial		1.0 2.0				4.0 7.0				9.0		13.0		17.0		24.0		30.0		168 hours	
Test	Test Spec. Lim. /3										/4												@25°C			
#	Parameters	Units	min	max	mean	sd	mean	sd	mean	sd	mean	sd	mean	sd	mean	sd	mean	sd	mean	sd	mean	sd	mean	sd	mean	sd
1	+Icc	mA	0.0	4.67	3.27	1.03E-04	3.23	9.73E-05	3.19	9.98E-05	3.12	1.08E-04	3.05	1.14E-04	3.03	1.16E-04	2.94	1.25E-04	2.86	1.29E-04	2.82	1.26E-04	2.75	1.27E-04	2.85	1.21E-04
2	-Icc	mA	-4.67	0.0	-9.72	1.00E-04	-9.68	9.23E-05	-9.64	9.60E-05	-9.57	9.86E-05	-9.5	1.07E-04	-9.48	1.11E-04	-9.4	1.19E-04	-9.32	1.24E-04	-9.28	1.20E-04	-9.17	1.22E-04	-9.28	1.15E-04
3	vos	μV	-25	25	50.5	1.91E-06	50.1	1.32E-06	50	7.56E-07	50.1	7.87E-07	71.8	4.41E-05	-120	4.07E-05	50.3	1.15E-06	50.1	1.09E-06	49.9	5.11E-08	-148	1.89E-06	-9.64	5.42E-05
4	P_IIB	nA	-40	40	8.19	1.41E-09	-4.24	3.16E-08	-2.46	3.37E-08	-1.46	3.73E-08	4	3.97E-08	-5.48	3.98E-08	2.78	4.27E-08	8.38	4.46E-08	-2.53	4.06E-08	-7.19	4.19E-08	130	3.16E-08
5	N_IIB	nA	-40	40	-5.92	1.69E-09	-1.94	3.09E-08	-1.89	3.28E-08	-1.97	3.66E-08	-14.68	3.86E-08	-25	3.90E-08	-17.7	4.20E-08	-1.27	4.39E-08	-2.54	3.97E-08	-31.5	4.07E-08	111	3.06E-08
6	P_VOUT_2k	v	12		13.4	5.67E-01	13.6	7.84E-01	13.56	4.77E-01	13.88	4.47E-02	13.92	4.47E-02	14	1.64E-02	14	3.52E-02	14	1.44E-02	14	1.19E-02	14	1.44E-02	14	1.05E-02
7	N_VOUT_2k	v	-12		-13.8	1.01E-02	-13.8	1.68E-07	-13.8	1.68E-07	-13.8	1.69E-07	-13.8	1.69E-07	-13.8	1.08E-02	-13.8	1.18E-02	-13.8	1.20E-02	-13.8	1.20E-02	-13.8	1.09E-02	-13.8	1.36E-02
8	GBW	MHz	5		10	0	10	0	10	0	10	0	10	0	10	0	10	0	10	0	10	0	10	0	10	0
9	Slew Rate	V/µs	1.70		2.5	0	2.5	0	2.5	0	2.5	0	2.5	0	2.5	0	2.5	0	2.5	0	2.5	0	2.5	0	2.5	0

Notes:

Radiation sensitive parameters: VOS, P_IIB, N_IIB.

^{1/ +}Icc, -Icc, N Vout and P IIB measurements were taken when Input Voltage to the Positive Input of the OP27 is at -300 μV.

^{2/} N IIB and P Vout measurements were taken when Input Voltage to the Positive Input of the OP27 is at +600 μV.

^{3/} These are manufacturer's pre-irradiation data sheet specification limits. No post-irradiation limits were provided by the manufacturer at the time the tests were performed.

^{4/} Due to a power outage, the devices were in the bias circuit overnight with no power, allowing some annealing to take place.